


PCN Number:	20170926005	PCN Date:	September 27, 2017
Title:	Datasheet for TMDS181, TMDS181I		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process
Notification Details			
Description of Change:			
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.</p>			
		TMDS181, TMDS181I <small>SLASE75D – AUGUST 2015 – REVISED SEPTEMBER 2017</small>	
Changes from Revision C (July 2016) to Revision D			Page
• Added Note 5 to the <i>Power Supply Electrical Characteristic</i> table			8
• Deleted text "which is needed for certain HDMI CTS test." from the third paragraph in the <i>Overview</i> section			24
• Changed section: <i>Input Signal Detect Block</i>			28
• Changed H to X in the first row of the HPD_SNK column in Table 12			47
• Changed the IN_Dx column in Table 12			47
The datasheet number will be changing.			
Device Family	Change From:	Change To:	
TMDS181, TMDS181I	SLASE75C	SLASE75D	
These changes may be reviewed at the datasheet links provided.			
http://www.ti.com/product/TMDS181			
Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
TMDS181IRGZR	TMDS181IRGZT	TMDS181RGZR	TMDS181RGZT

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com